



# 超结-场效应晶体管

## Super Junction -MOSFET

### FHP65R190A/FHA65R190A/FHF65R190A

#### 主要参数 MAIN CHARACTERISTICS

ID	20A
VDSS	650 V
Rdson-typ ( @Vgs=10V)	0.16Ω
Qg-typ	36.5nC

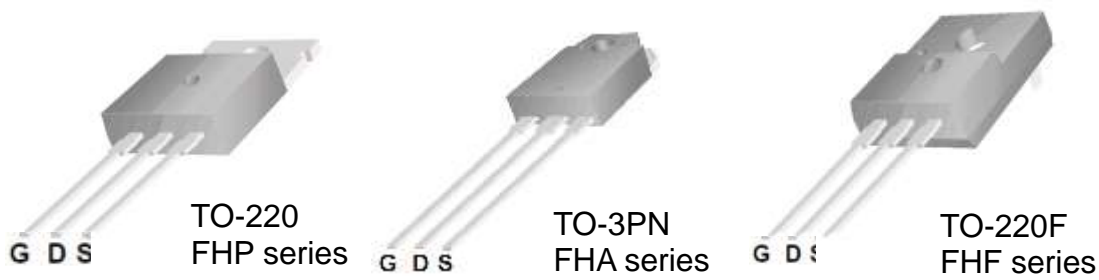
#### 产品特性 FEATURES

低栅极电荷	Low gate charge
低 Crss (典型值 2.1pF)	Low Crss (typical 2.1pF )
开关速度快	Fast switching
100%经过雪崩测试	100% avalanche tested
高抗 dv/dt 能力	Improved dv/dt capability
RoHS 产品	RoHS product

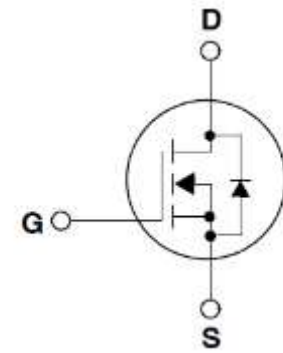
#### 用途 APPLICATIONS

高频开关电源	High efficiency switch mode power supplies
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#### 封装形式 Package



#### 等效电路 Equivalent Circuit



#### 绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 Parameter	符号 Symbol	数值 Value			单位 Unit
		FHP65R190A	FHF65R190A	FHA65R190A	
最高漏极-源极直流电压 Drain-Source Voltage	V <sub>DS</sub>	650			V
连续漏极电流* Drain Current -continuous *	I <sub>D</sub> (T <sub>C</sub> =25°C)	20			A
	I <sub>D</sub> (T <sub>C</sub> =100°C)	12.6			A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	I <sub>DM</sub>	65			A
最高栅源电压 Gate-Source Voltage	V <sub>GS</sub>	±30			V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E <sub>AS</sub>	485			mJ
雪崩电流 (注 1) Avalanche Current (note 1)	I <sub>AR</sub>	9.5			A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	E <sub>AR</sub>	25			mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	15			V/ns
耗散功率 Power Dissipation	P <sub>D</sub> (T <sub>C</sub> =25°C)	150	34	208	W
	-Derate above 25°C	1.2	0.26	3.06	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~+150			°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T <sub>L</sub>	300			°C

\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature

## 电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
<b>关态特性 Off –Characteristics</b>						
漏-源击穿电压 Drain-Source Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	650	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	I <sub>D</sub> =250μA, referenced to 25°C	-	0.6	-	V/°C
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>C</sub> =25°C	-	-	1	μA
		V <sub>DS</sub> =480V, T <sub>C</sub> =125°C	-	-	100	μA
栅极体漏电流 Gate-body leakage current	I <sub>GSS</sub> (F/R)	V <sub>DS</sub> =0V, V <sub>GS</sub> =±30V	-	-	±100	nA
<b>通态特性 On-Characteristics</b>						
阈值电压 Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	3.0	4.0	V
静态导通电阻 Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V , I <sub>D</sub> =10.0A	-	0.16	0.19	Ω
正向跨导 Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> =20A (note 4)	-	18.8	-	S
<b>动态特性 Dynamic Characteristics</b>						
输入电容 Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V, f=1.0MHz	-	1505	-	pF
输出电容 Output capacitance	C <sub>oss</sub>		-	68	-	
反向传输电容 Reverse transfer capacitance	C <sub>rss</sub>		-	2.1	-	
<b>开关特性 Switching Characteristics</b>						
栅电阻 Gate Resistance	R <sub>g</sub>	f=1.0MHz, V <sub>DS</sub> OPEN	-	9.8	-	Ω
延迟时间 Turn-On delay time	t <sub>d(on)</sub>	V <sub>DS</sub> =400V, I <sub>D</sub> =10A, R <sub>G</sub> =3.3Ω V <sub>GS</sub> =10V (note 4, 5)	-	38	-	ns
上升时间 Turn-On rise time	t <sub>r</sub>		-	39	-	ns
延迟时间 Turn-Off delay time	t <sub>d(off)</sub>		-	170	-	ns
下降时间 Turn-Off Fall time	t <sub>f</sub>		-	47	-	ns
栅极电荷总量 Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =480V , I <sub>D</sub> =10A , V <sub>GS</sub> =10V (note 4, 5)	-	36.5	-	nC
栅-源电荷 Gate-Source charge	Q <sub>gs</sub>		-	8.7	-	nC
栅-漏电荷 Gate-Drain charge	Q <sub>gd</sub>		-	12.5	-	nC
<b>漏-源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings</b>						
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current		I <sub>S</sub>	-	-	20	A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current		I <sub>SM</sub>	-	-	65	A
正向压降 Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =20A	-	0.9	1.4	V
反向恢复时间 Reverse recovery time	t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =10A ,dI <sub>F</sub> /dt=100A/μs (note 4)	-	318	-	ns
反向恢复电荷 Reverse recovery charge	Q <sub>rr</sub>		-	5.5	-	μC

## 热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	FHP65R190A	FHA65R190A	FHF65R190A	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	Rth(j-c)	0.83	0.6	3.7	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	Rth(j-A)	62	40	80	°C/W

注释:

- 1: 脉冲宽度由最高结温限制
- 2: L=10mH, IAS=9.5A, VDD=50V, RG=25 Ω, 起始结温 TJ=25°C
- 3: ISD ≤20A, di/dt ≤200A/μs, VDD≤BVDSS, 起始结温 TJ=25°C
- 4: 脉冲测试: 脉冲宽度 ≤300μs, 占空比≤2%
- 5: 基本与工作温度无关

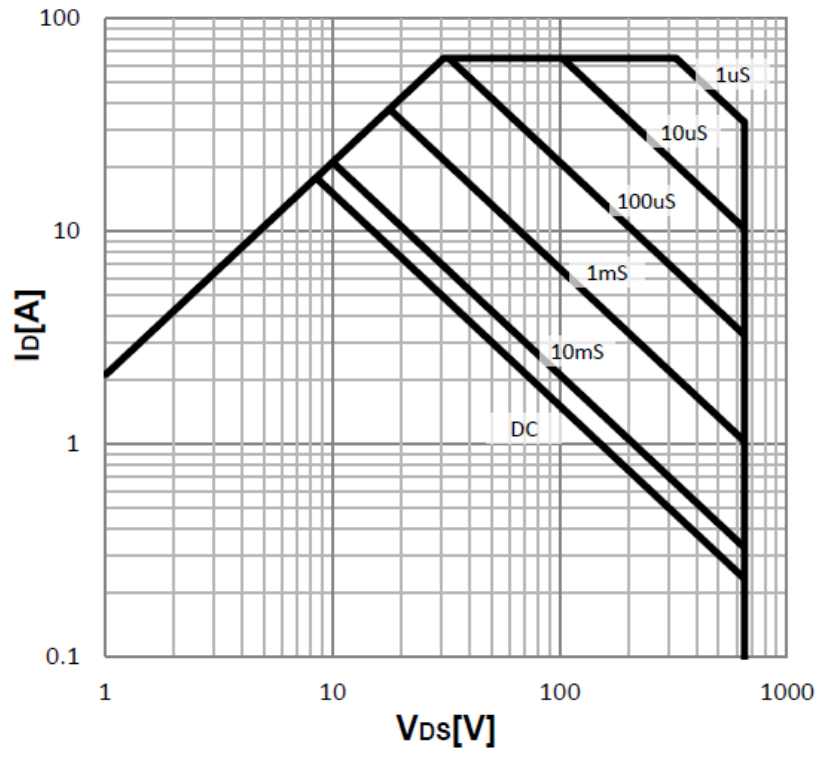
Notes:

- 1: Pulse width limited by maximum junction temperature
- 2: L=10mH, IAS=9.5A, VDD=50V, RG=25 Ω, Starting TJ=25°C
- 3: ISD ≤20A, di/dt ≤200A/μs, VDD≤BVDSS, Starting TJ=25°C
- 4: Pulse Test: Pulse Width ≤300μs, Duty Cycle≤2%
- 5: Essentially independent of operating temperatur

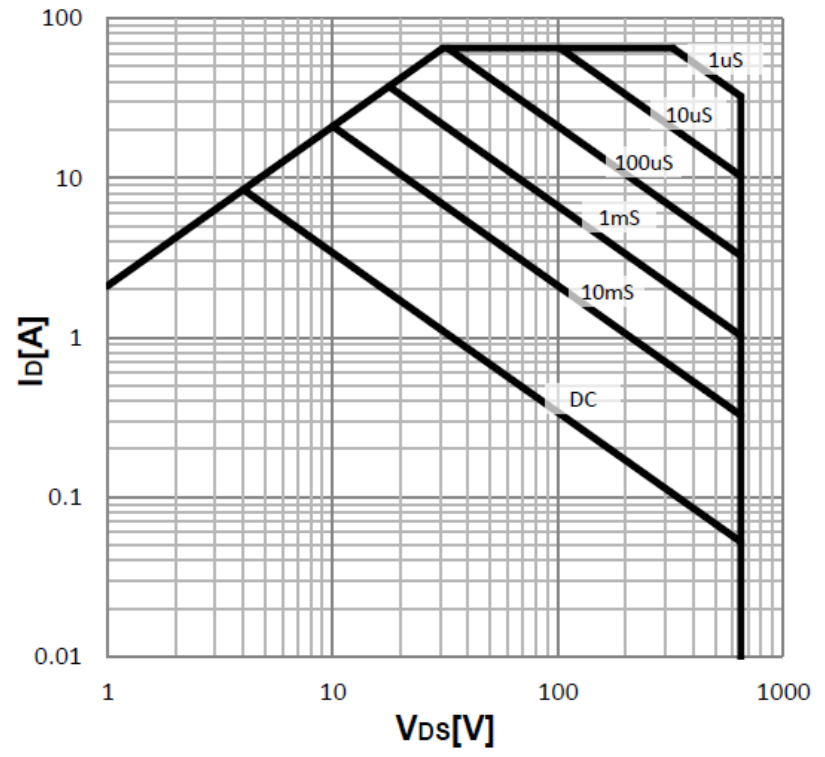
# 典型特性曲线

## ELECTRICAL CHARACTERISTIC CURVE

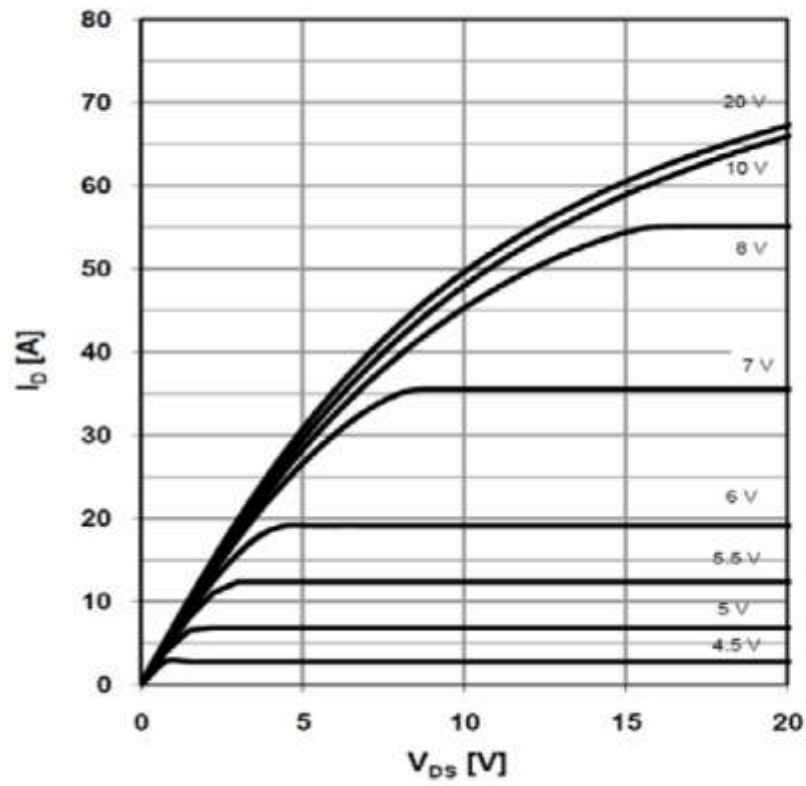
Safe operating area TC=25 °C  
parameter: tp; TO-220, TO-3PN



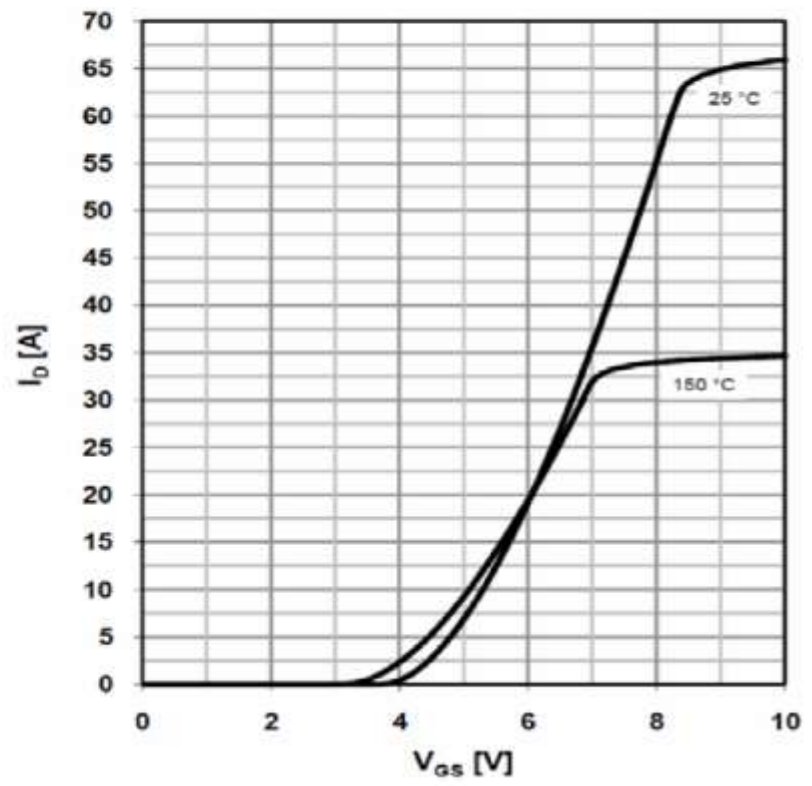
Safe operating area TC=25 °C  
parameter: tp; TO-220FullPAK



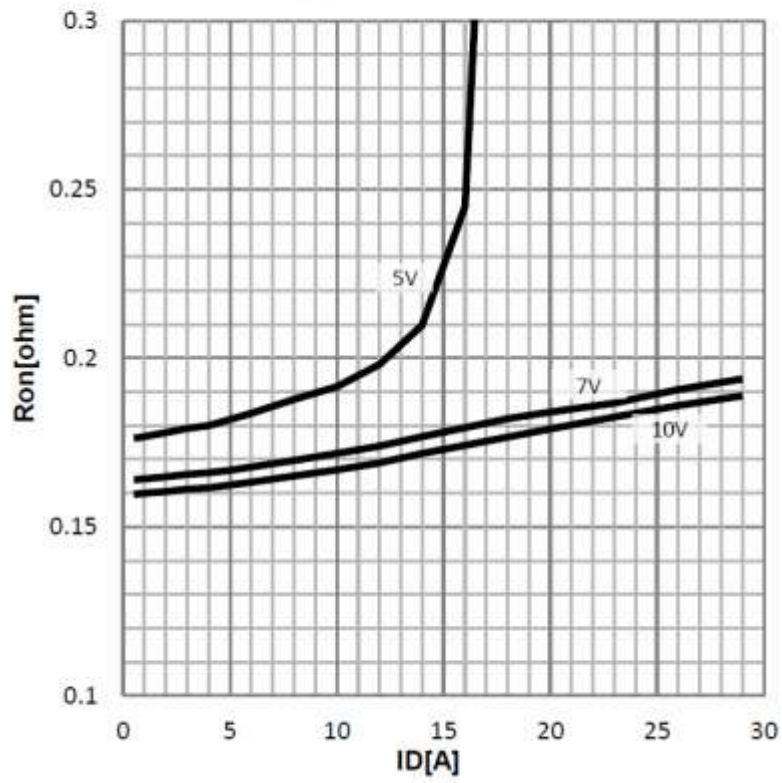
Typ. output characteristics  $T_j=25\text{ }^\circ\text{C}$   
parameter:  $V_{GS}$



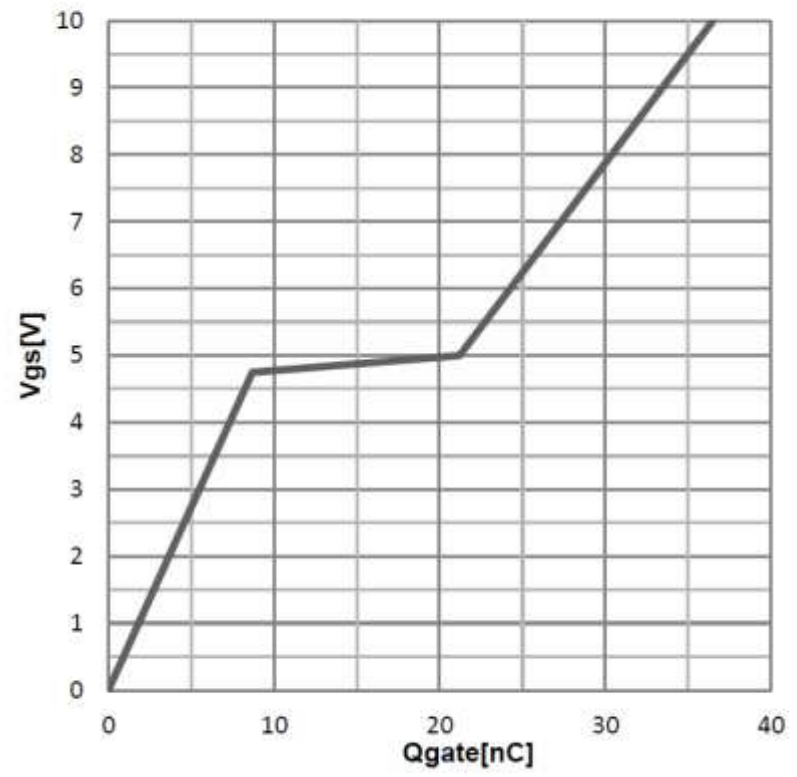
Typ. transfer characteristics



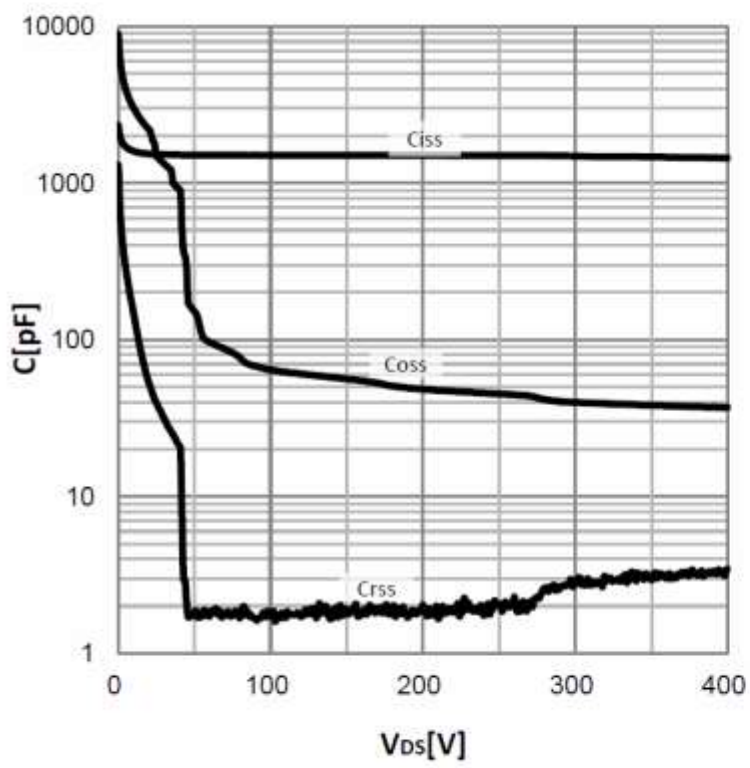
Typ. drain-source on-state resistance parameter :  $V_{GS}$



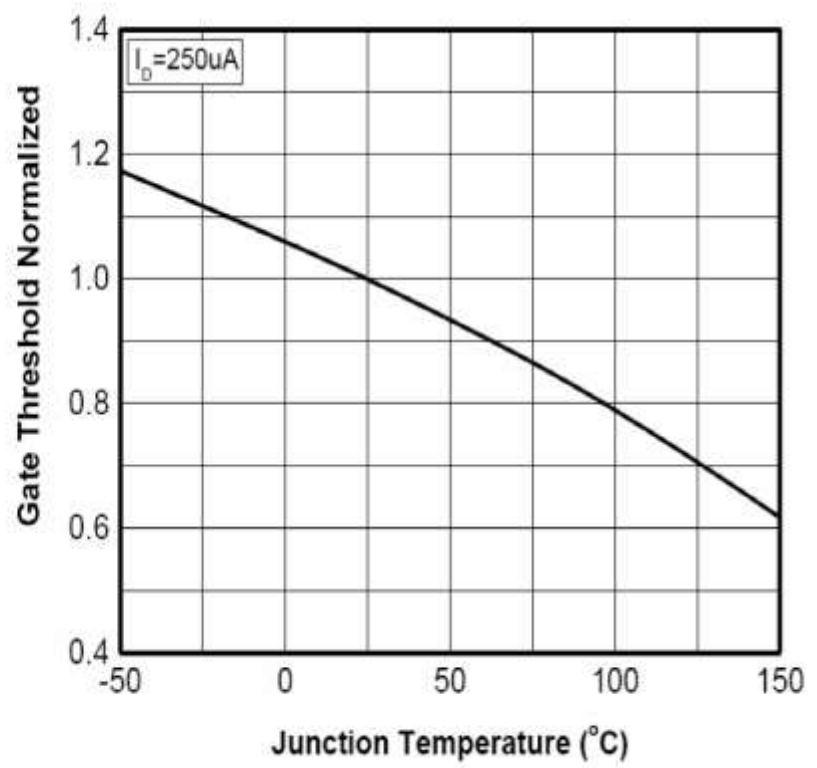
Typ. gate charge characteristics



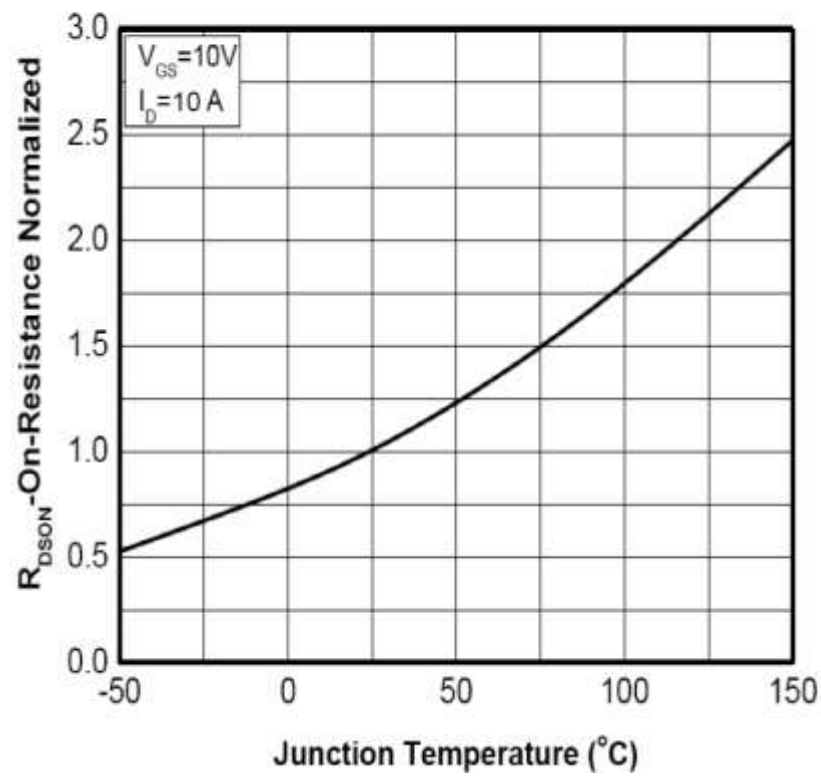
Typ. capacitances



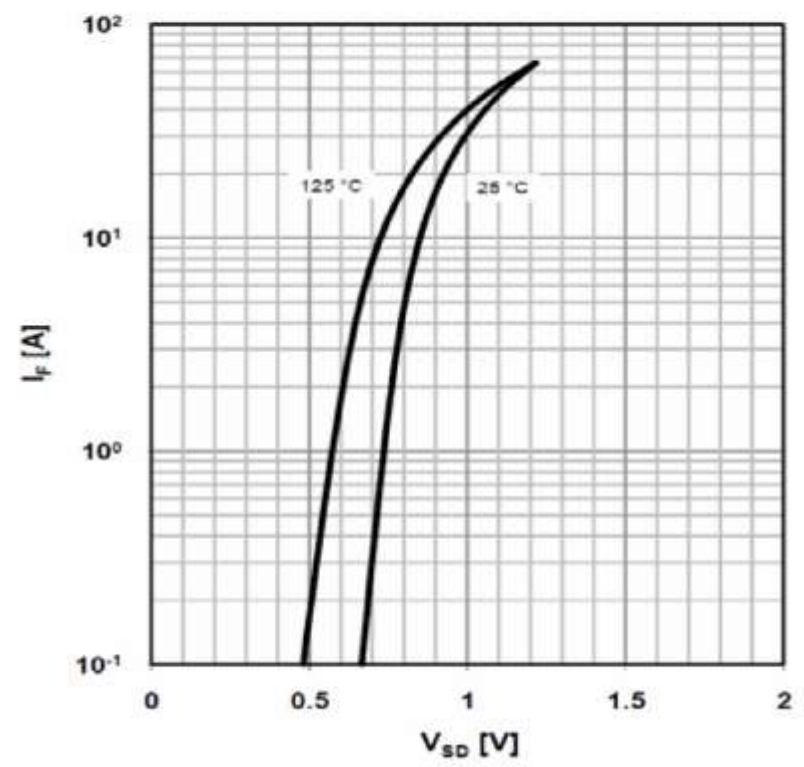
Normalized  $V_{GS(th)}$  characteristics



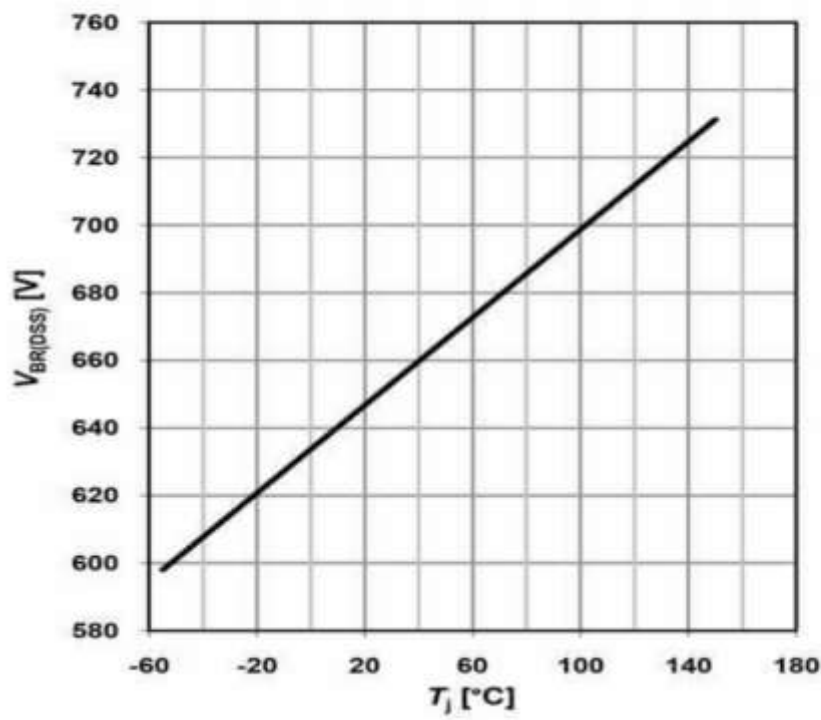
Normalized on-resistance vs temperature



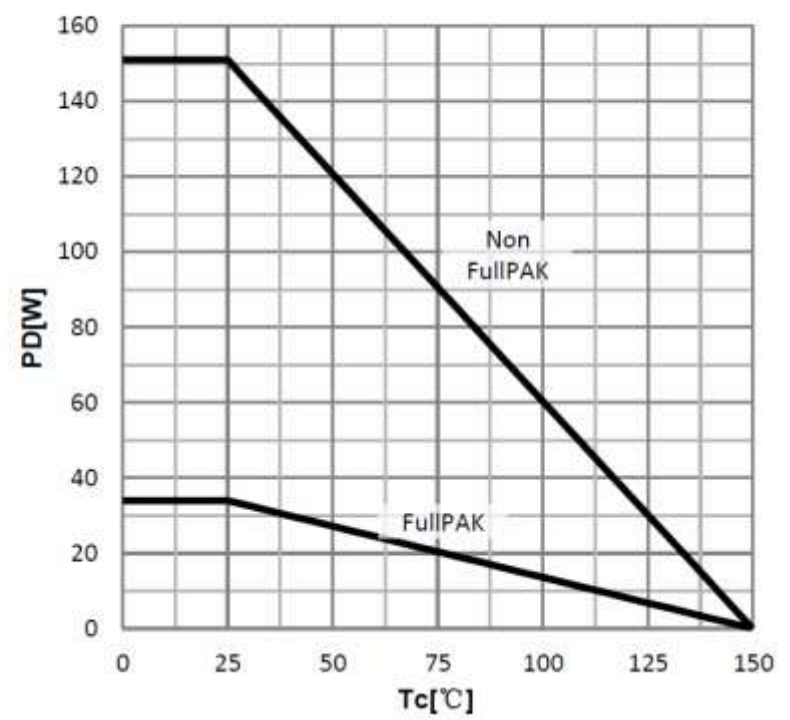
Forward characteristics of reverse diode



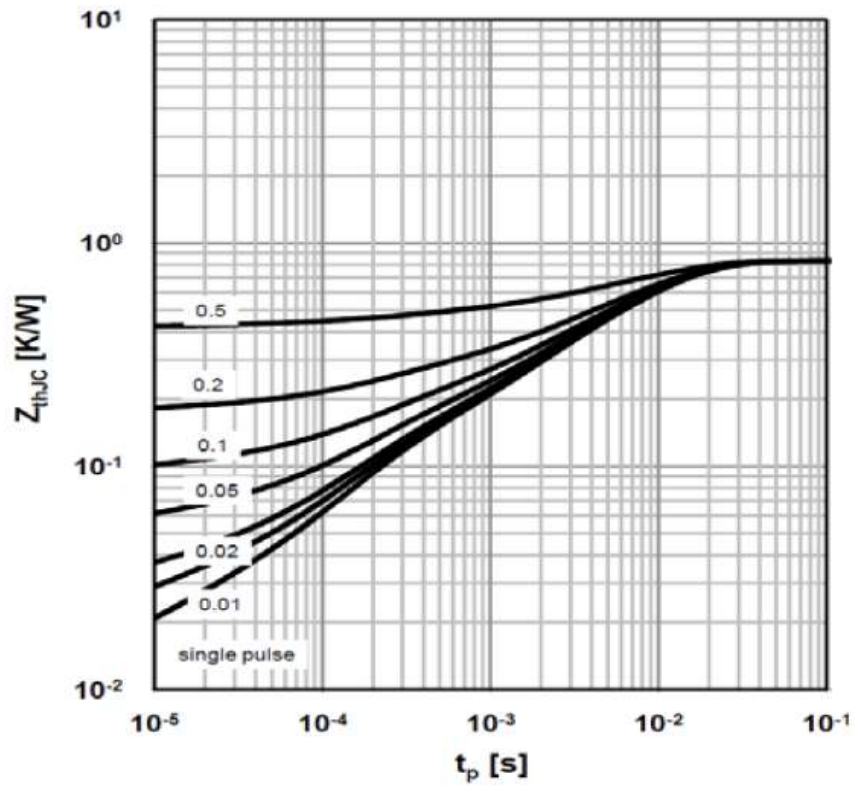
Drain-source breakdown voltage



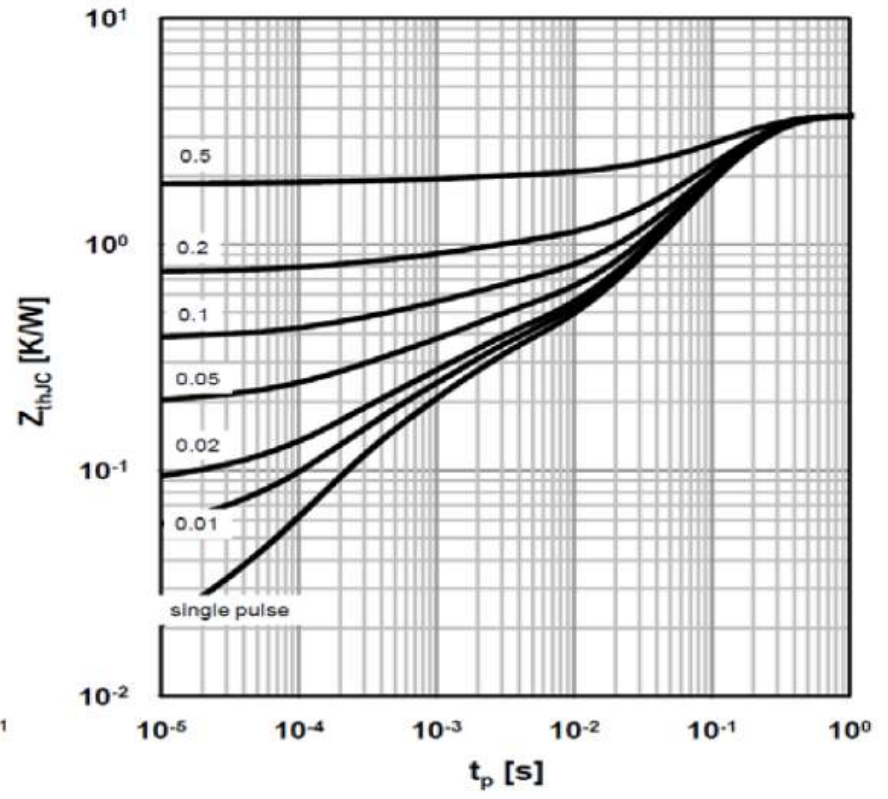
Power dissipation



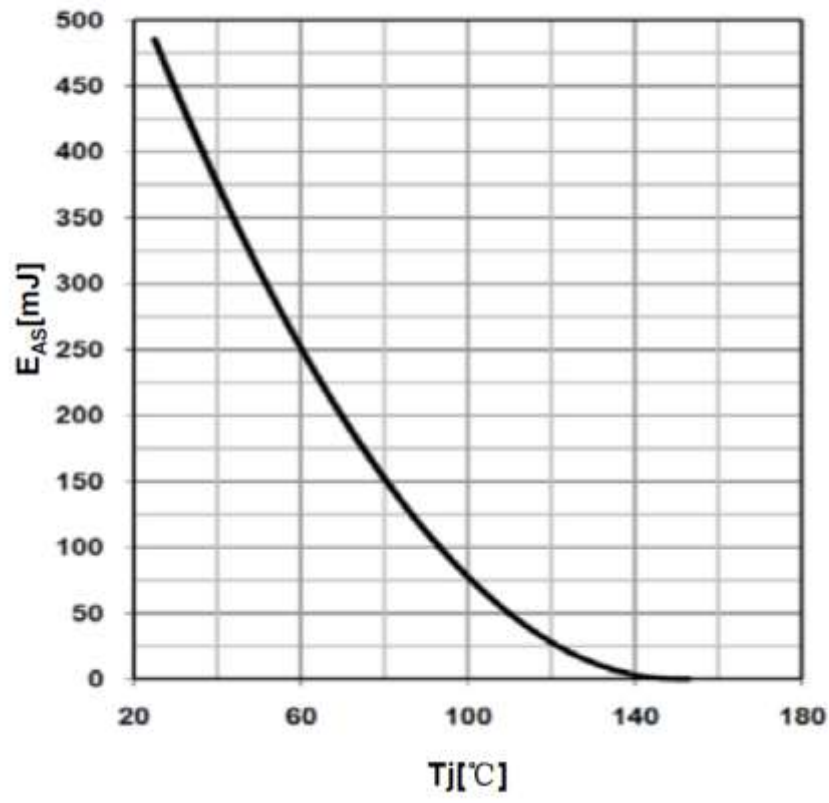
Max. transient thermal impedance  
parameter:  $D=tp/T$ ; TO-220, TO-3PN



Max. transient thermal impedance  
parameter:  $D=tp/T$ ; TO-220FullPAK

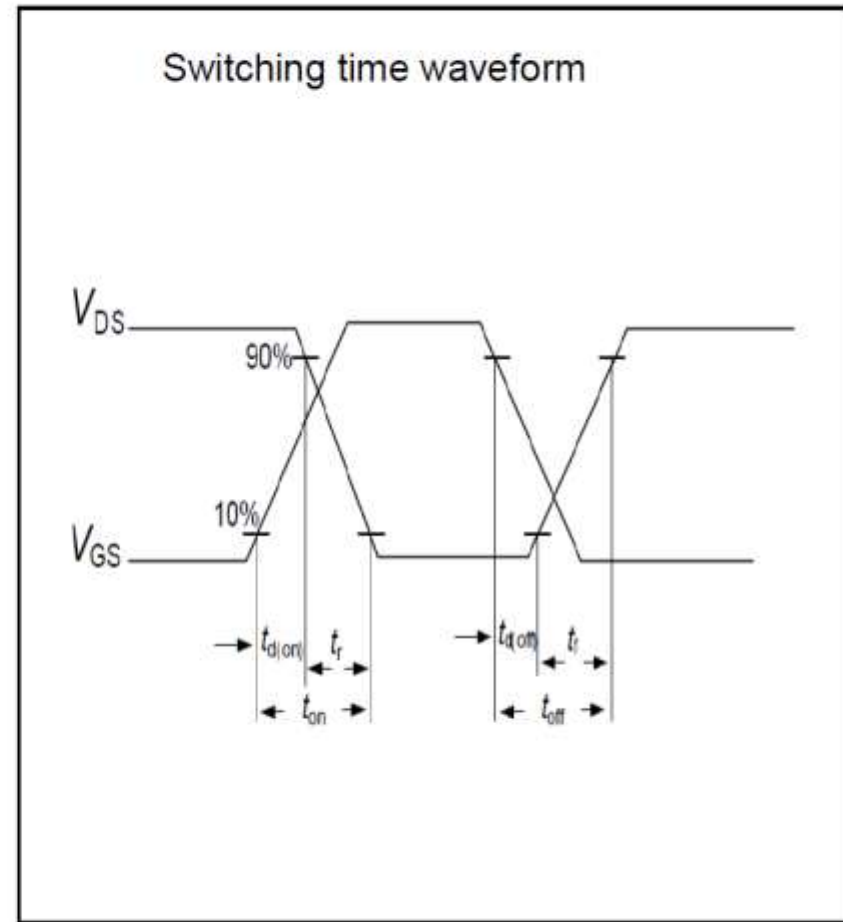
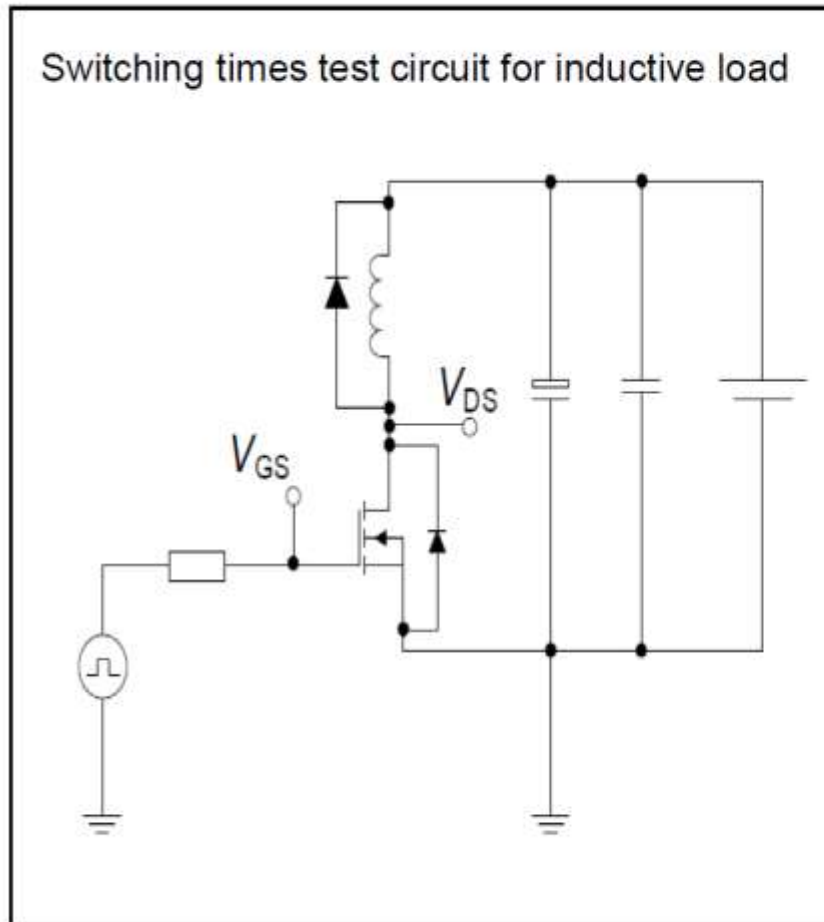


Avalanche energy

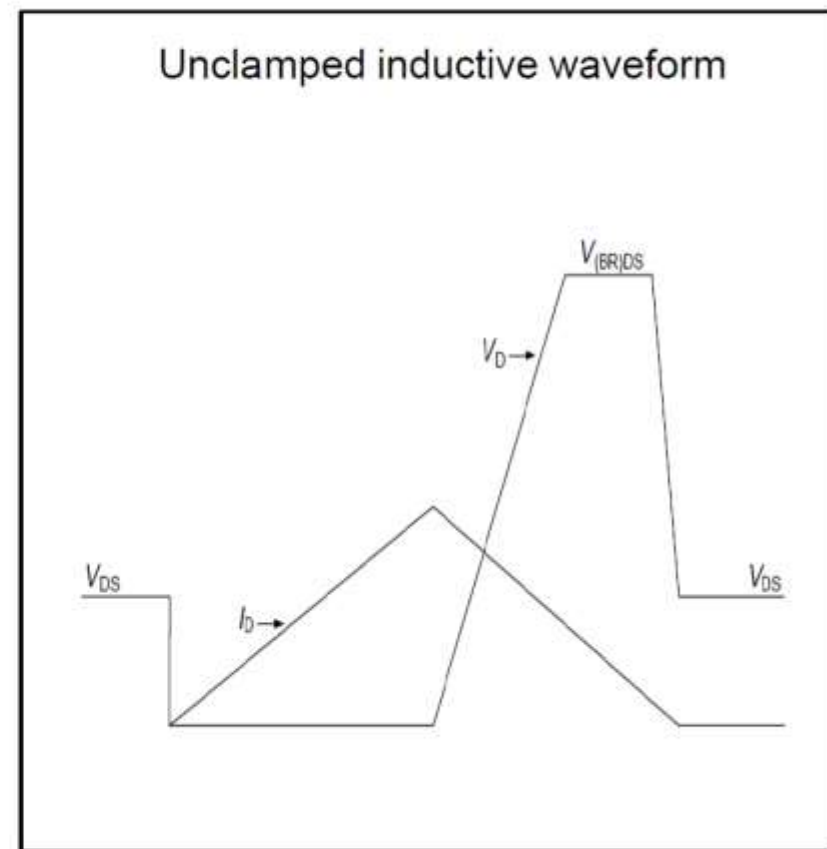
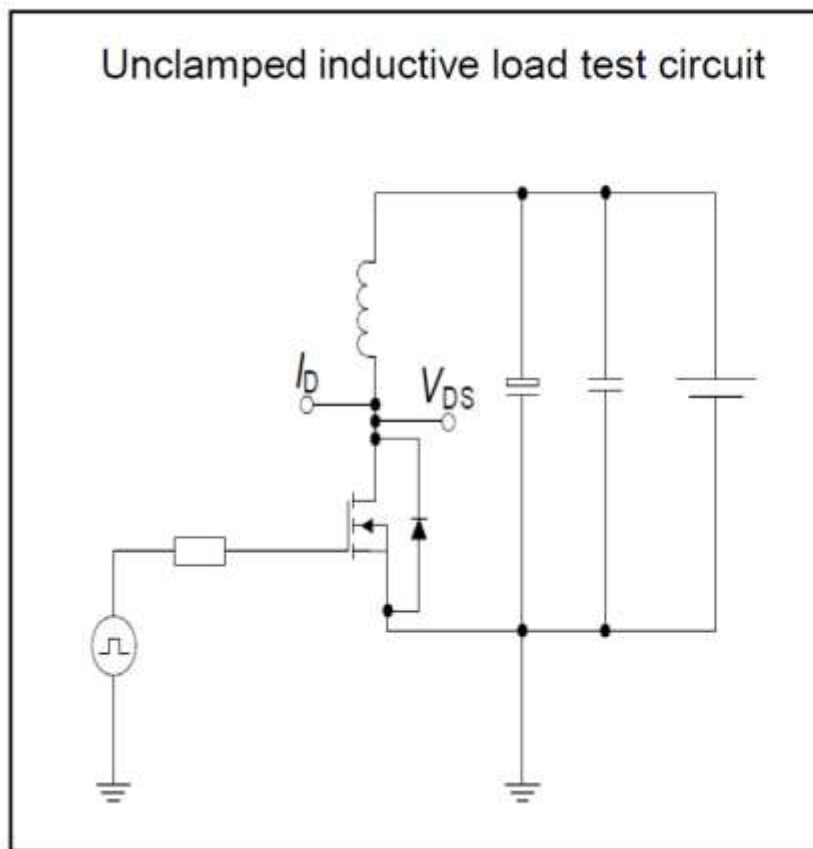


## 测试电路 Test circuits

### Switching times test circuit and waveform for inductive load

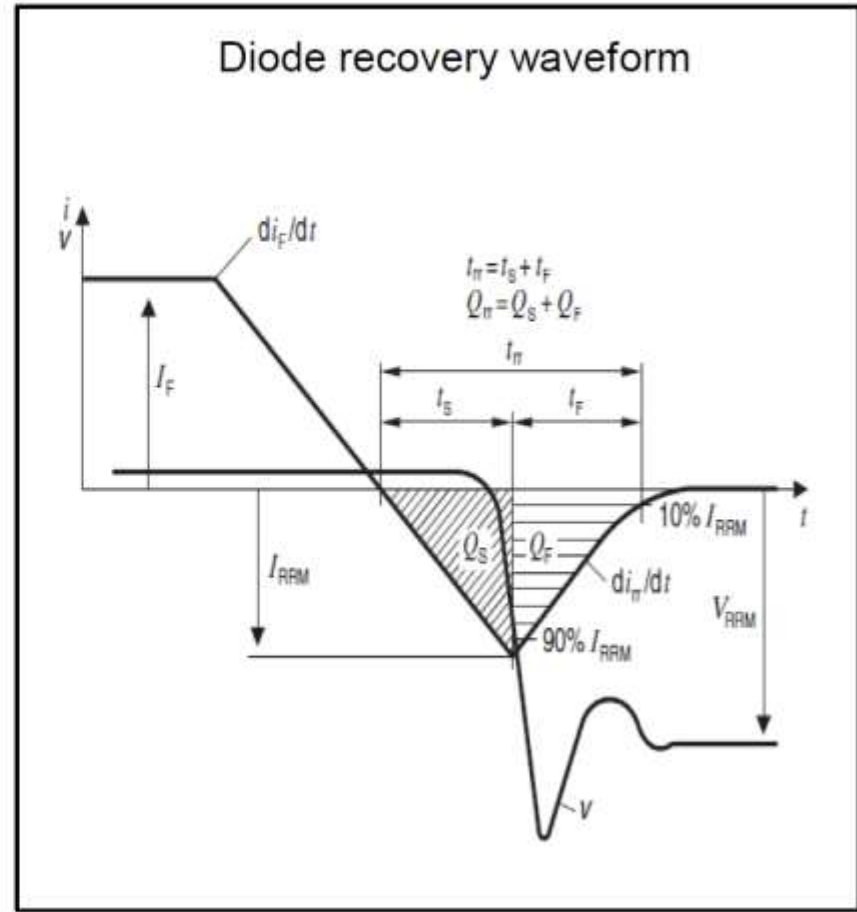
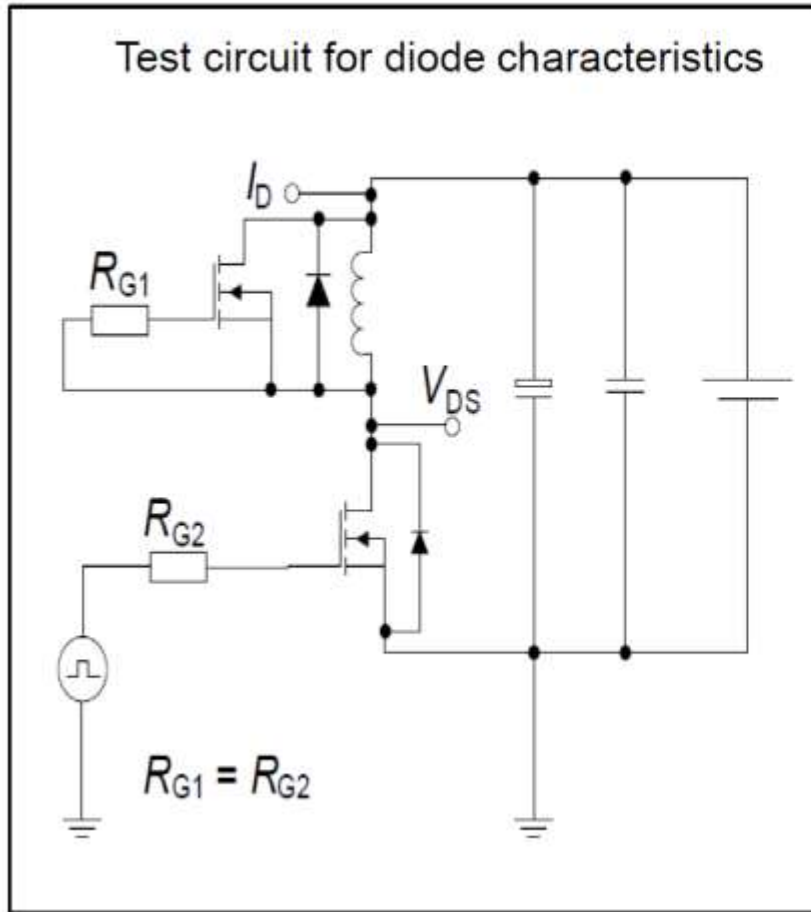


### Unclamped inductive load test circuit and waveform

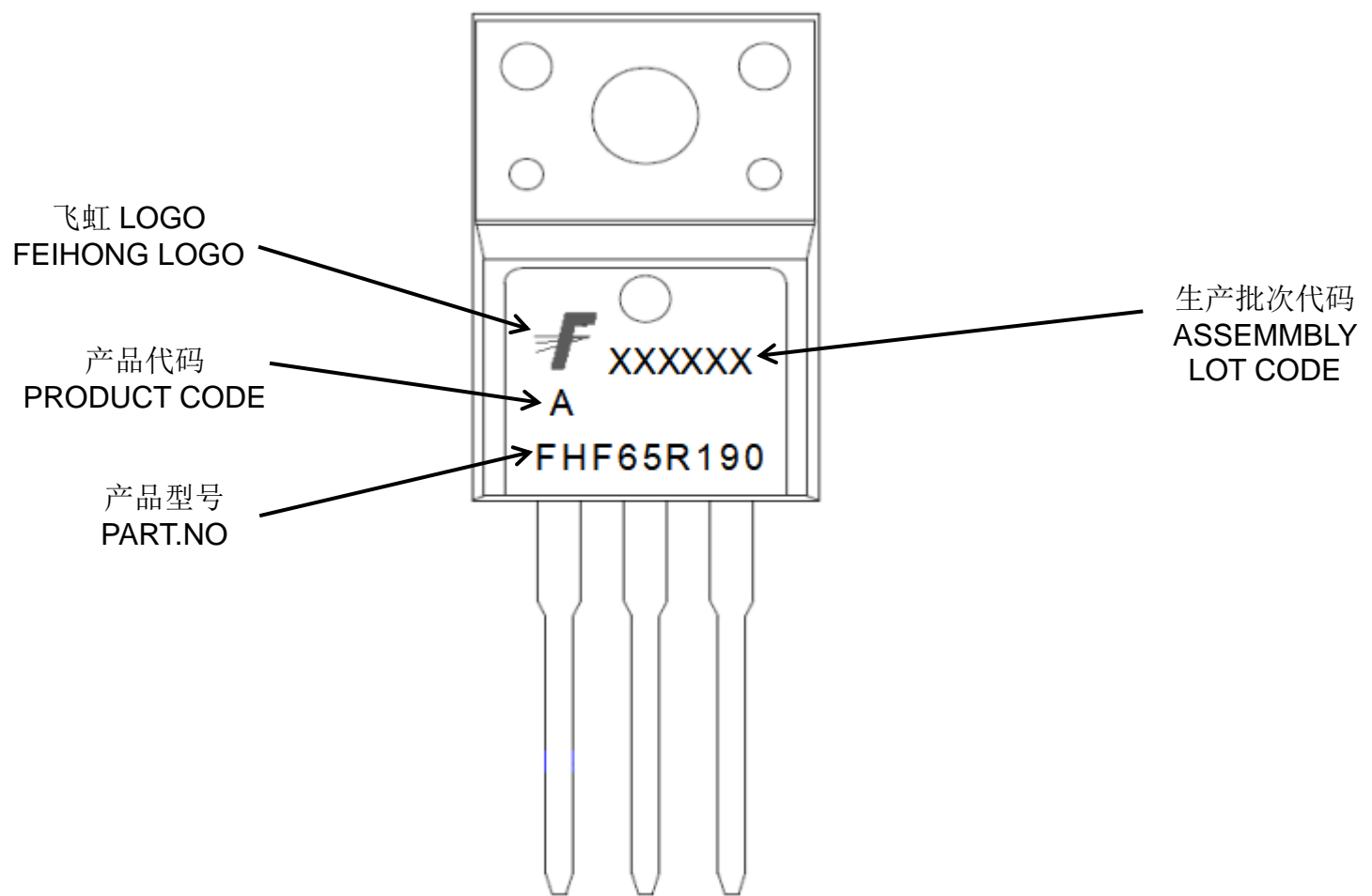
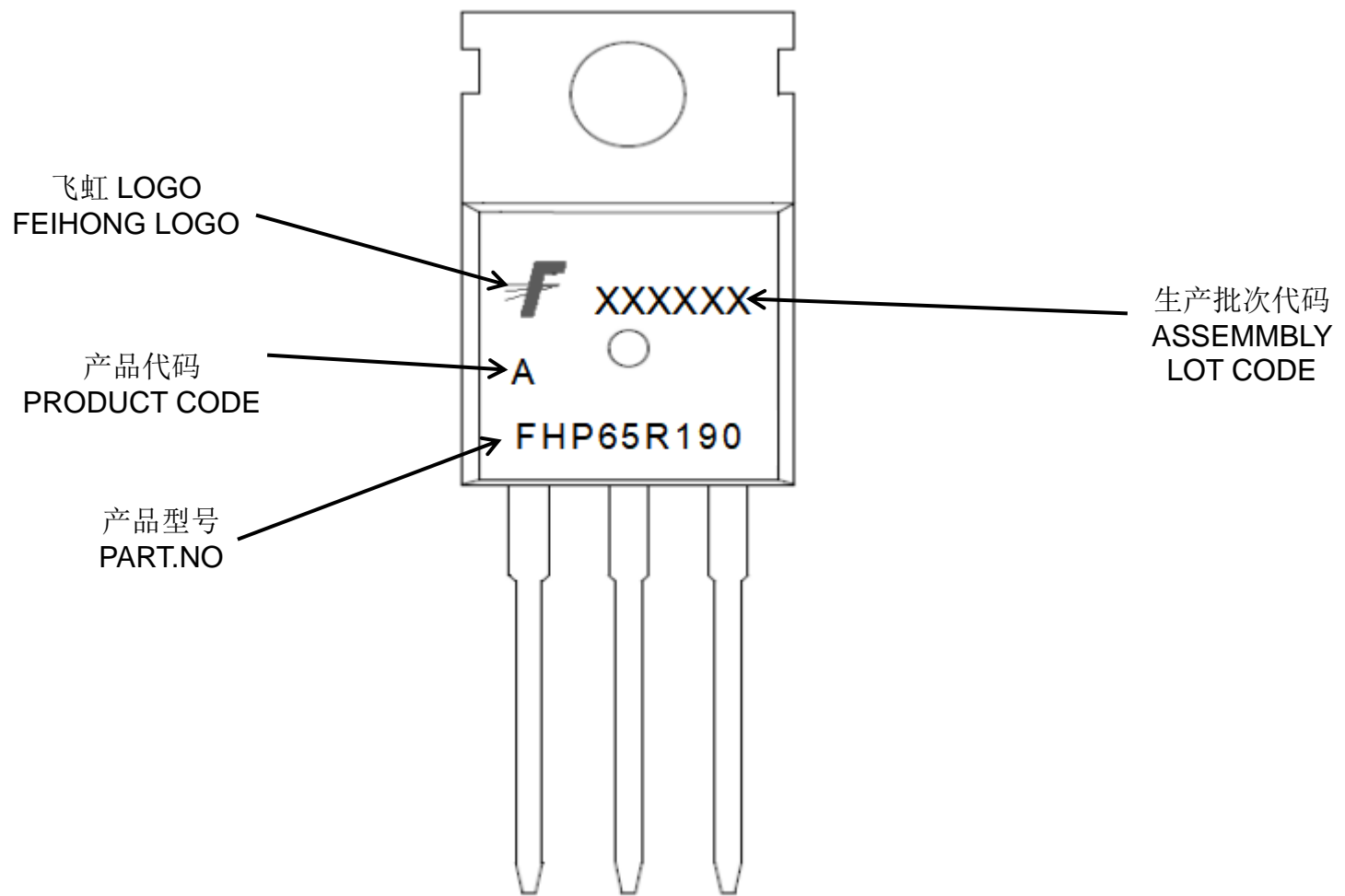


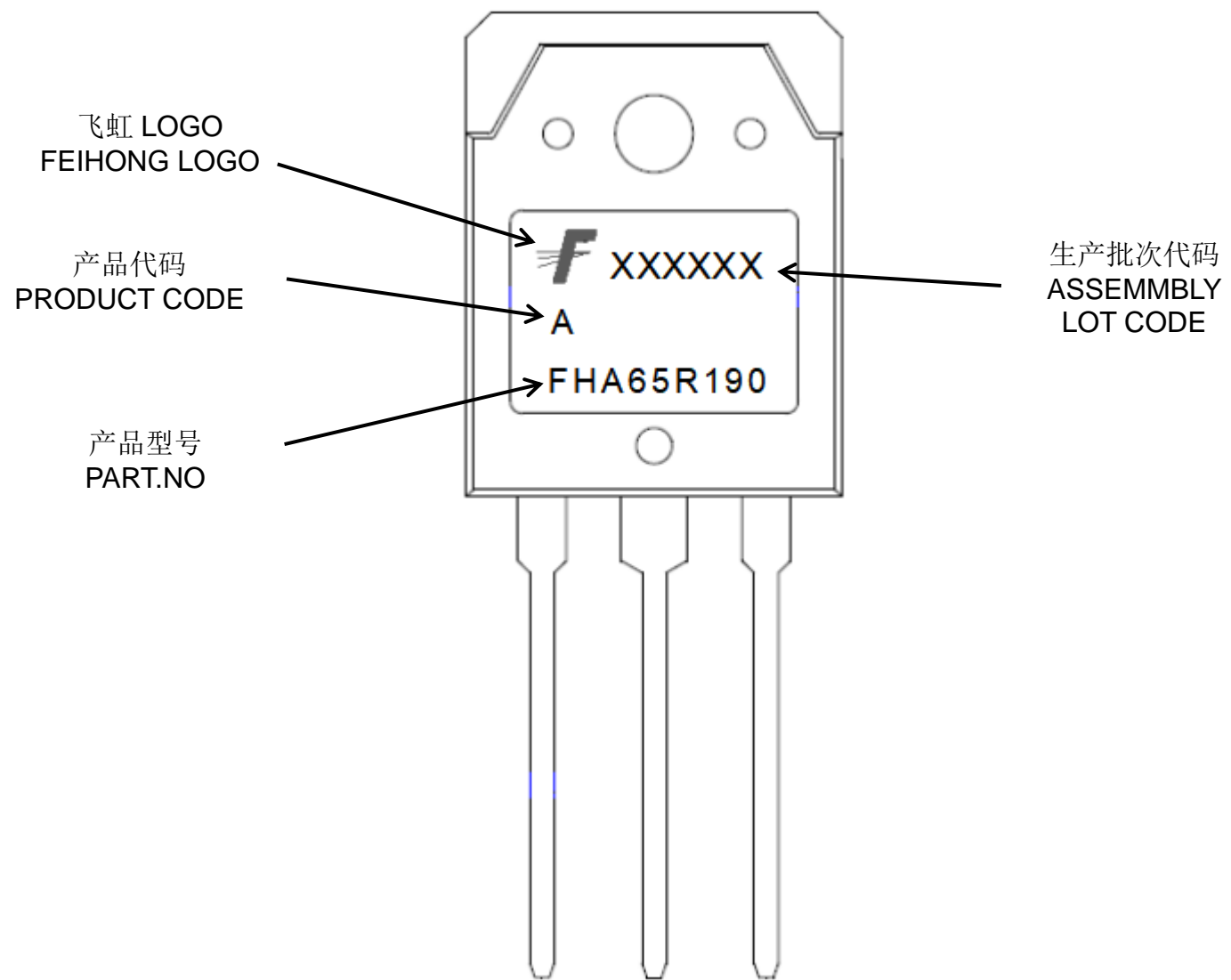


Test circuit and waveform for diode characteristics



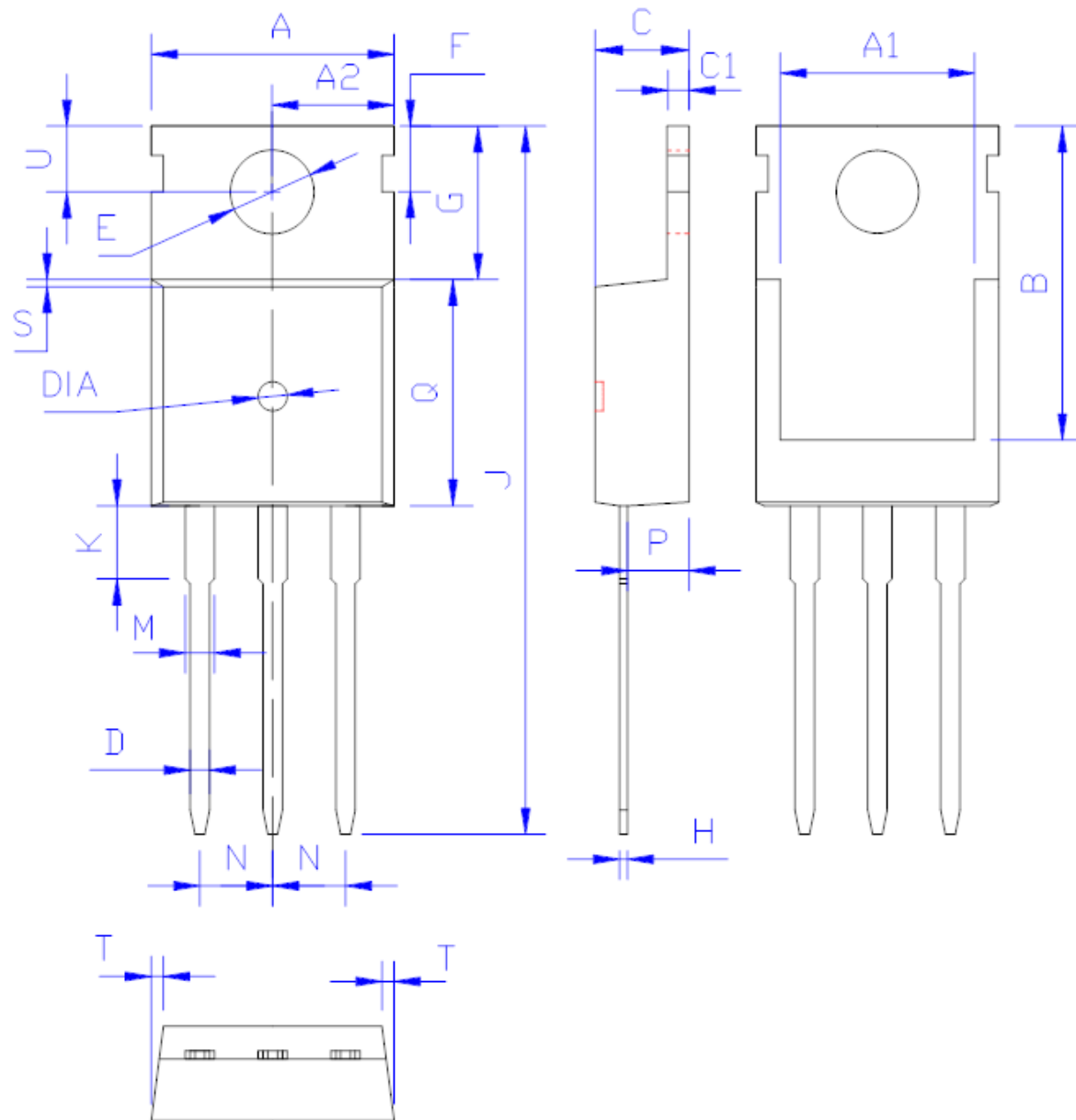
印记 Marking:





外形尺寸： Package Dimension:

TO-220



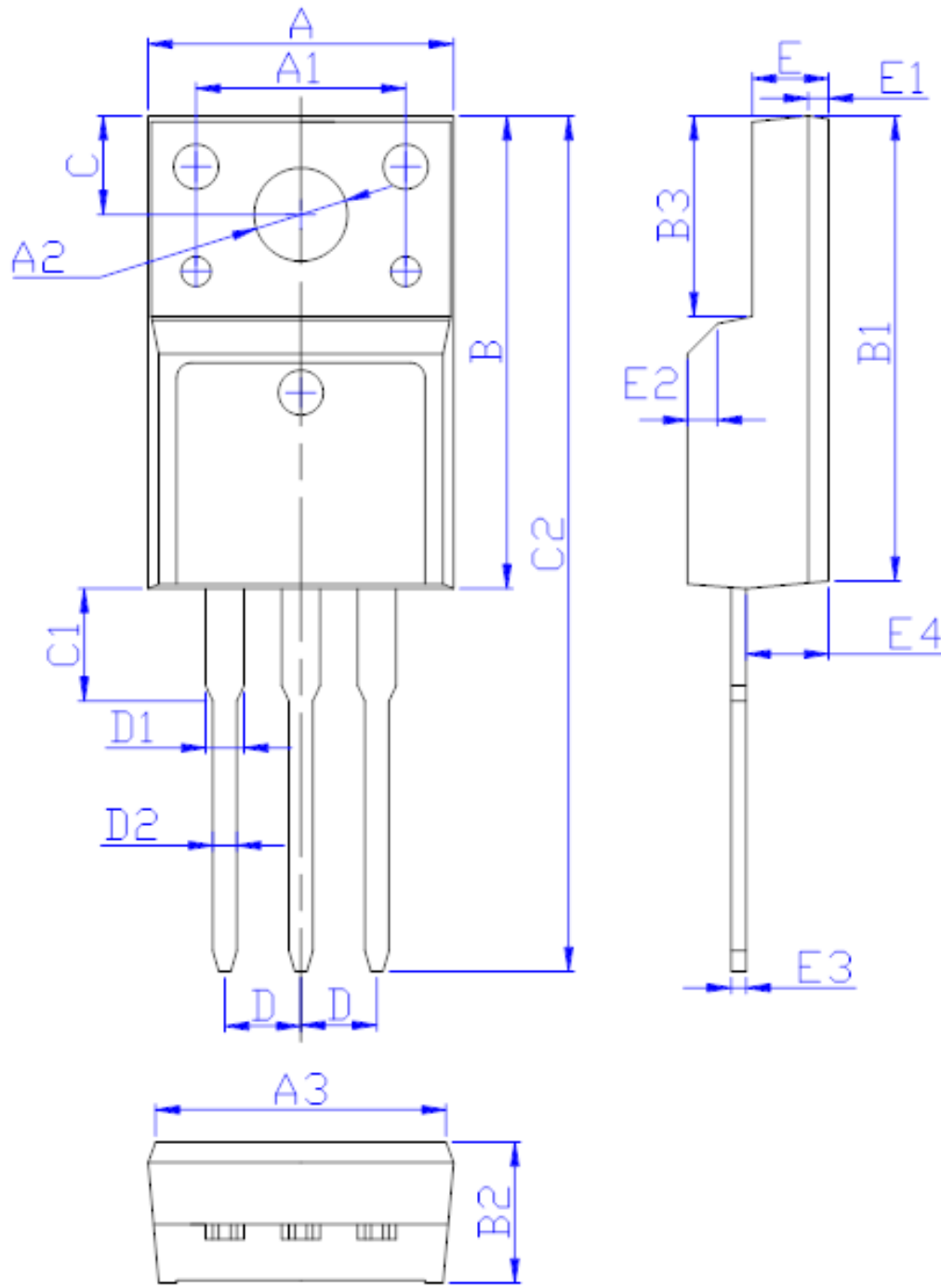
DIM	MILLIMETERS
A	10.00 ± 0.30
A1	8.00 ± 0.30
A2	5.00 ± 0.30
B	13.20 ± 0.40
C	4.50 ± 0.20
C1	1.30 ± 0.20
D	0.80 ± 0.20
E	3.60 ± 0.20
F	3.00 ± 0.30
G	6.60 ± 0.40
H	0.50 ± 0.20
J	28.88 ± 0.50
K	3.00 ± 0.30
M	1.30 ± 0.30
N	Typical 2.54
P	2.40 ± 0.40
Q	9.20 ± 0.40
S	0.25 ± 0.15
T	0.25 ± 0.15
U	2.80 ± 0.30
DIA	宽 1.50 ± 0.10 深 0.50 MAX

(Units: mm)

外形尺寸:

Package Dimension:

TO-220F

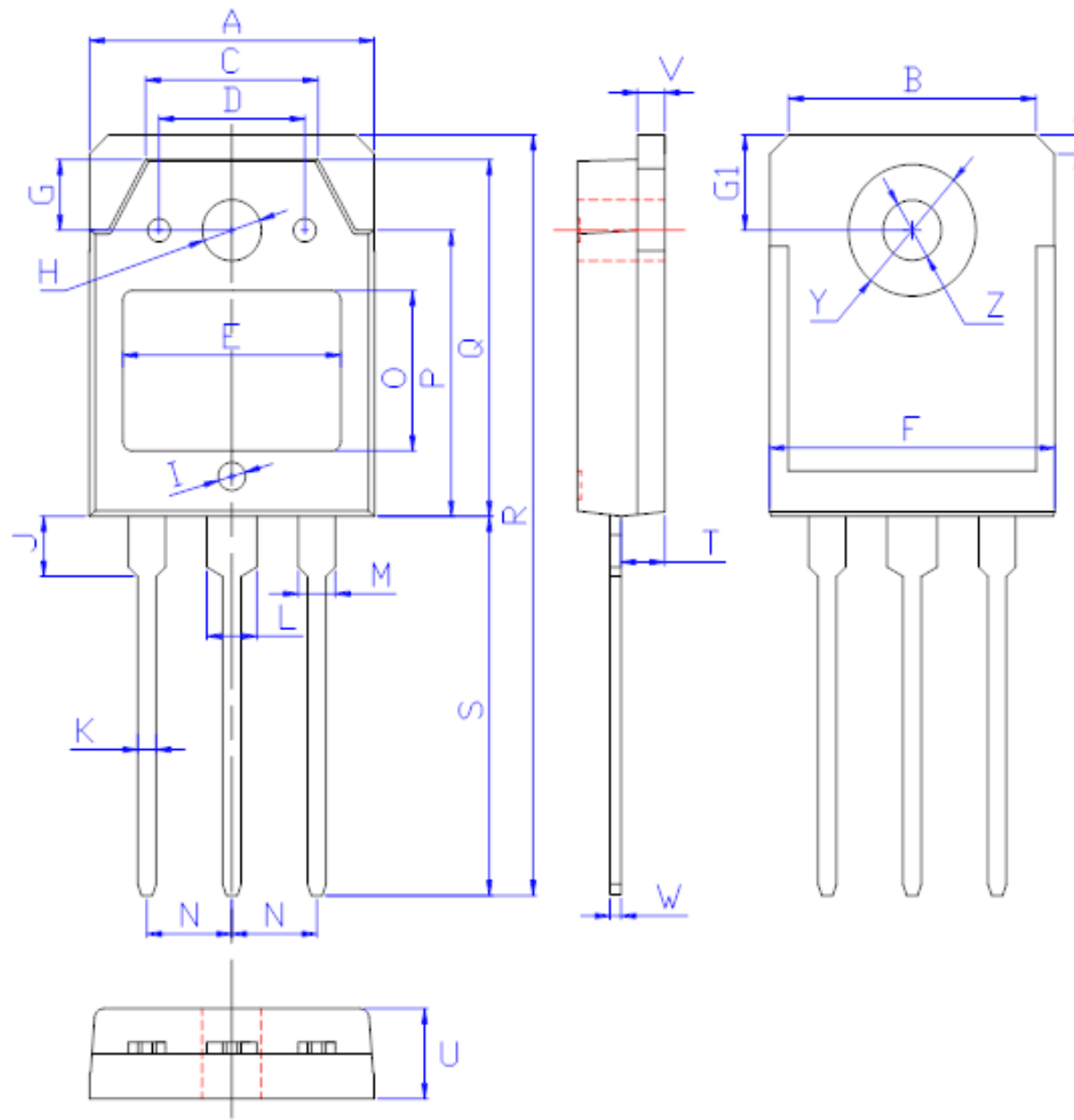


DIM	MILLIMETERS
A	10.16±0.30
A1	7.00±0.20
A2	3.12±0.20
A3	9.70±0.30
B	15.90±0.50
B1	15.60±0.50
B2	4.70±0.30
B3	6.70±0.30
C	3.30±0.25
C1	3.25±0.30
C2	28.70±0.50
D	Typical 2.54
D1	1.47 (MAX)
D2	0.80±0.20
E	2.55±0.25
E1	0.70±0.25
E2	1.0×45°
E3	0.50±0.20
E4	2.75±0.30

(Units: mm)

外形尺寸: Package Dimension:

TO-3PN



DIM	MILLIMETERS
A	15.60 ± 0.30
B	13.60 ± 0.30
C	9.50 ± 0.30
D	8.00 ± 0.30
E	11.85 ± 0.30
F	15.65 ± 0.30
G	3.80 ± 0.30
G1	5.00 ± 0.30
H	φ 3.50 ± 0.30
I	φ 1.50 ± 0.30 深 0.15 ± 0.15
J	3.20 ± 0.30
K	1.00 ± 0.15
L	3.10 ± 0.15
M	2.10 ± 0.15
N	5.45 ± 0.30
O	8.40 ± 0.30
P	13.90 ± 0.30
Q	18.70 ± 0.30
R	40.00 ± 0.60
S	20.00 ± 0.40
T	2.40 ± 0.30
U	4.80 ± 0.30
V	1.50 ± 0.15
W	0.60 ± 0.15
X	1.80 ± 0.40
Y	7.00 ± 0.30
Z	3.20 ± 0.30

(Units: mm)